



VMDSEMI

**VSTL065R15BNB**

**Datasheet**

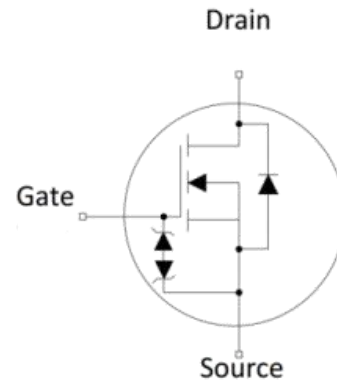


VMDSEMI

## General Description

$V_{(BR)DSS}$	$R_{DS(ON)_{max}}$	$I_D$
650V	1500mΩ@10V	5A

## Symbol

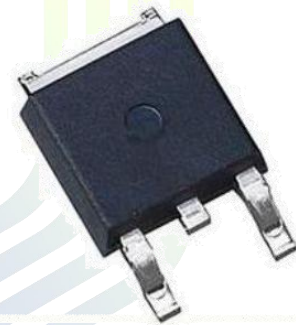


Symbol of VSTL065R15BNB

## Features

- Low RDS(on) & FOM
- Extremely low switching loss
- Excellent stability and uniformity
- Ultra-fast and robust body diode
- Integrated ESD protection diode

## Package Type



TO-252

Package Type of VSTL065R15BNB

## Application

- PC power
- Telecom power
- Server power
- EV Charger
- Motor driver

## Ordering Information

Product Name	Package	Marking
VSTL065R15BNB	TO-252	STL065R15BNB

**Absolute Maximum Ratings** ( $T_J=25\text{ }^\circ\text{C}$ , unless otherwise specified)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DS}$	650	V
Gate-Source Voltage	$V_{GS}$	$\pm 30$	V
Continuous Drain Current <sup>Note 1</sup>	$I_D$	5	A
Pulsed Drain Current <sup>Note 2</sup>	$I_{D, pulse}$	15	A
Continuous Diode Forward Current <sup>Note 1</sup>	$I_S$	5	A
Diode Pulsed Current <sup>Note 2</sup>	$I_{S, pulse}$	15	A
Max Power Dissipation <sup>Note 3</sup>	$P_D$	89	W
Avalanche Current, Single Pulse <sup>Note 4</sup>	$I_{AS}$	1.78	A
Avalanche Energy, Single Pulse <sup>Note 4</sup>	$E_{AS}$	95	mJ
Gate source ESD(HBM-C=100pF, R=1.5kΩ)	$V_{ESD(G-S)}$	Class 2	-
MOSFET dv/dt ruggedness, $V_{DS}=0\sim 480\text{V}$	dv/dt	50	V/ns
Reverse diode dv/dt, $V_{DS}=0\sim 480\text{V}$ , $I_{SD}\leq I_D$	dv/dt	50	V/ns
Operation and storage temperature	$T_J, T_{STG}$	-55 to 150	$^\circ\text{C}$

**Thermal Resistance**

Parameter	Symbol	Min	Typ	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	-	1.4	-	$^\circ\text{C/W}$
Thermal Resistance, Junction-to-Ambient <sup>Note 5</sup>	$R_{\theta JA}$	-	62.5	-	

**Notes:**

Note1: Calculated continuous current based on maximum allowable junction temperature.

Note2: Pulse width limited by safe operating area.

Note3: Based on max. junction temperature, using junction-case thermal resistance.

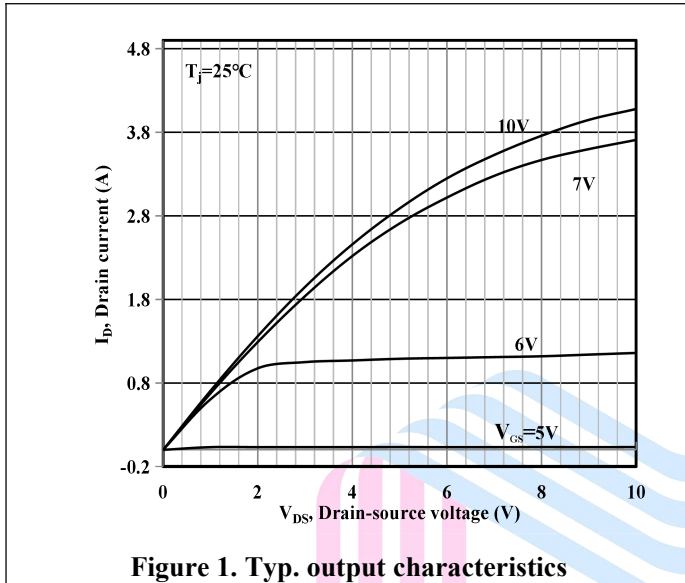
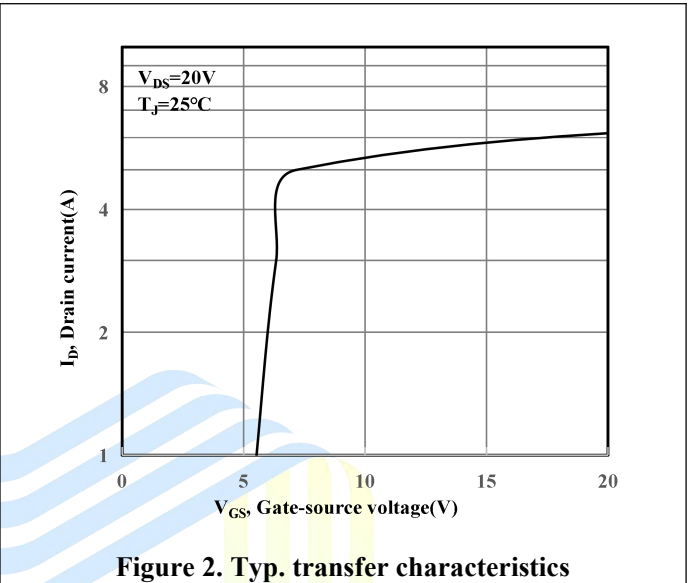
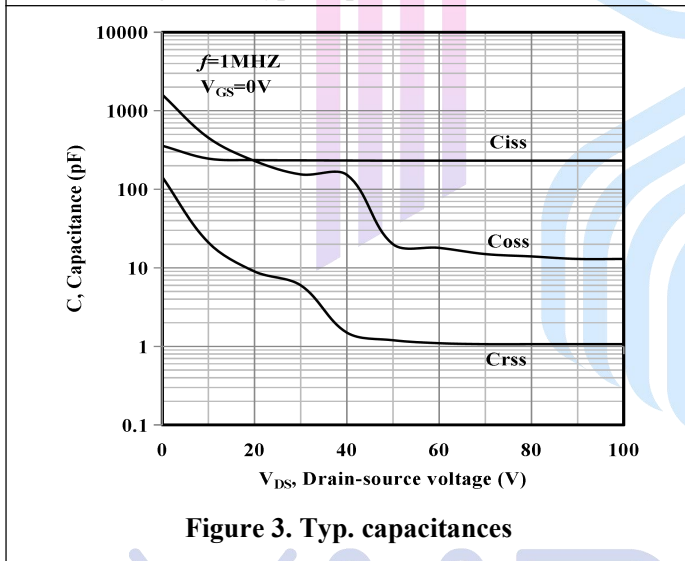
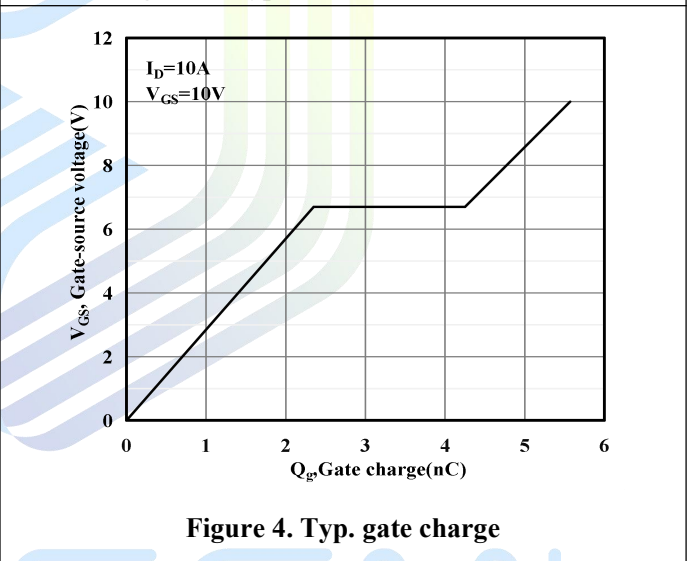
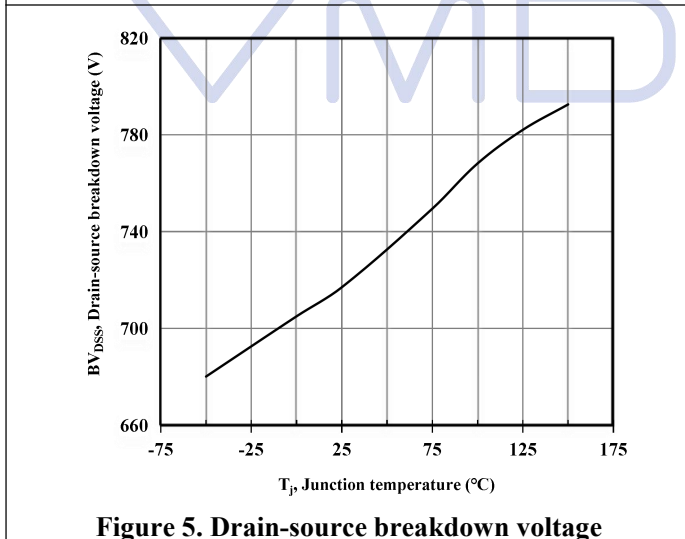
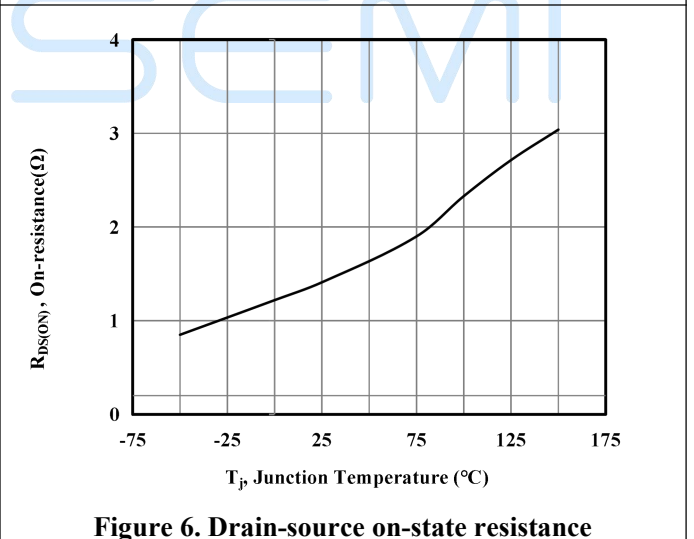
Note4:  $V_{DD}=100\text{V}$ ,  $V_{GS}=10\text{V}$ ,  $L=60\text{mH}$ , starting  $T_A=25\text{ }^\circ\text{C}$ .

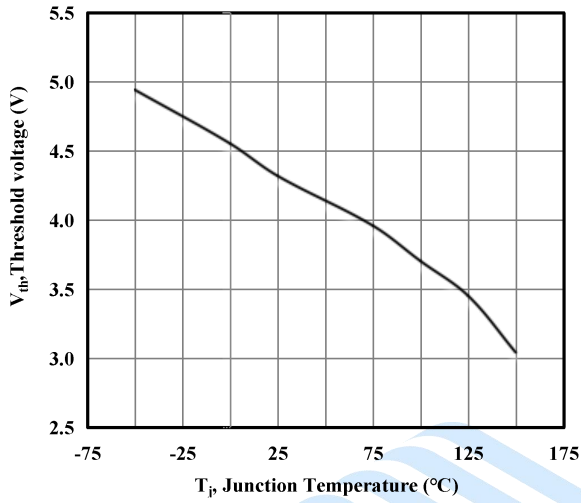
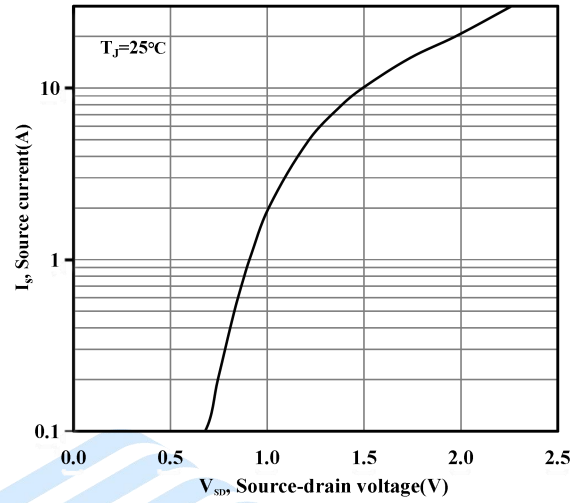
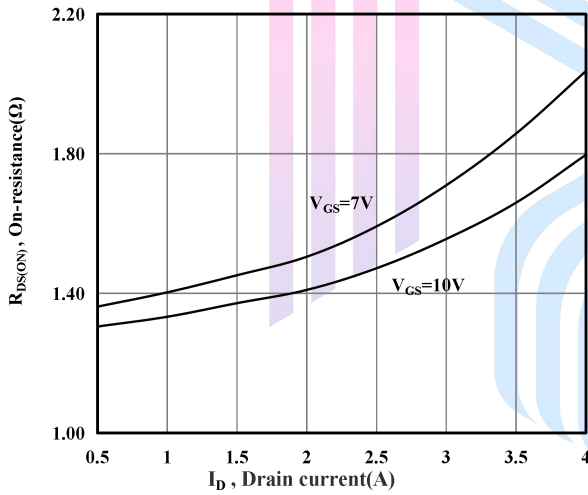
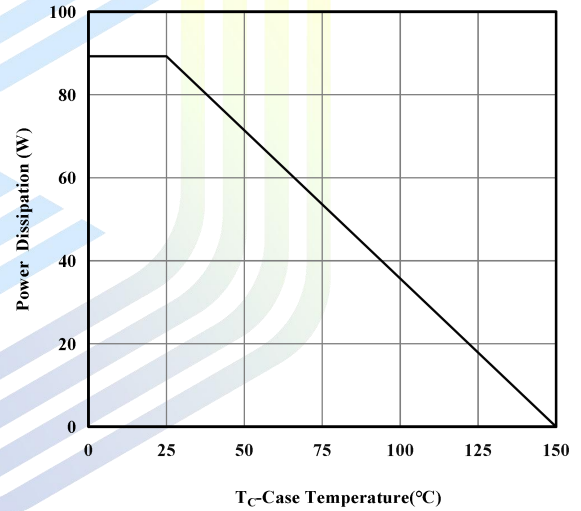
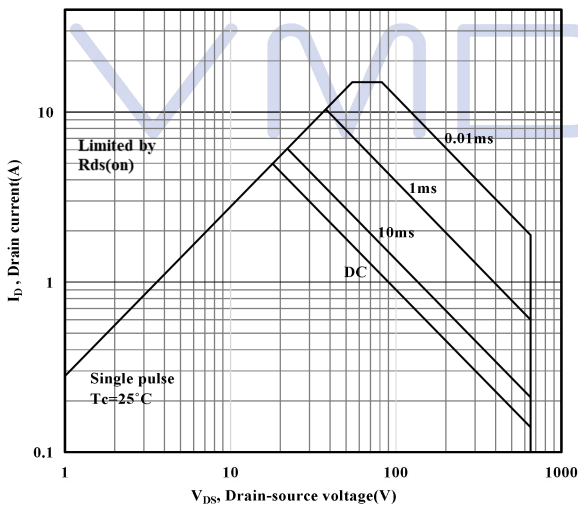
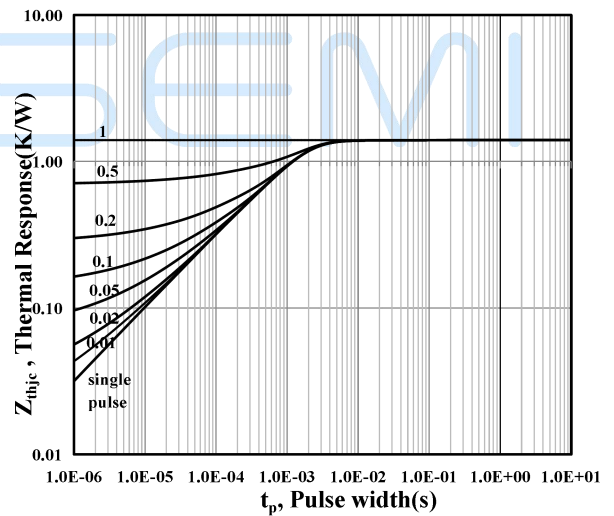
Note5: When mounted on 1 inch square copper board,  $t\leq 10\text{sec}$ . The value in any given application depends on the user's specific board design.

**Electrical Characteristics** ( $T_J=25\text{ }^\circ\text{C}$ , unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
<b>Statistic Characteristics</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	650	-	-	V
Drain-Source Leakage Current	$I_{DSS}$	$V_{DS}=650V, V_{GS}=0V$	-	-	10	$\mu A$
Gate-Source Leakage Current	Forward	$I_{GSSF}, V_{GS}=30V, V_{DS}=0V$	-	-	1	$\mu A$
	Reverse	$I_{GSSR}, V_{GS}=-30V, V_{DS}=0V$	-	-	-1	
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	3.0	4.3	5.0	V
Drain-Source On-State Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=2A$	-	1417	1500	$m\Omega$
Gate Resistance	$R_G$	$F=1MHz, \text{Open Drain}$	-	15.31	-	$\Omega$
<b>Dynamic Characteristics</b>						
Input Capacitance	$C_{iss}$	$V_{DS}=50V$	-	232	-	pF
Output Capacitance	$C_{oss}$	$V_{GS}=0V$	-	20	-	pF
Reverse Transfer Capacitance	$C_{rss}$	$f=1MHz$	-	1.2	-	pF
Turn-on Delay Time	$t_{d(on)}$	$V_{DS}=380V$	-	9.24	-	ns
Rise Time	$t_r$	$I_D=4A$	-	23.71	-	
Turn-off Delay Time	$t_{d(off)}$	$R_G=25\Omega$	-	15.2	-	
Fall Time	$t_f$	$V_{GS}=10V$	-	16.76	-	
<b>Gate Charge Characteristics</b>						
Gate to Source Charge	$Q_{gs}$	$V_{DS}=520V$ $I_D=10A$ $V_{GS}=0 \text{ to } 10V$	-	2.35	-	nC
Gate to Drain Charge	$Q_{gd}$		-	1.9	-	
Gate Charge Total	$Q_g$		-	5.57	-	
Gate Plateau Voltage	$V_{plateau}$		-	6.7	-	V
<b>Reverse Diode Characteristics</b>						
Drain-Source Diode Forward Voltage	$V_{SD}$	$V_{GS}=0V, I_S=1A$	-	0.88	-	V
Reverse Recovery Time	$t_{rr}$	$V_R=400V$	-	76.25	-	ns
Reverse Recovery Charge	$Q_{rr}$	$I_S=2A$	-	175	-	nC
Peak Reverse Recovery Current	$I_{rrm}$	$di/dt=100A/\mu s$	-	3.9	-	A

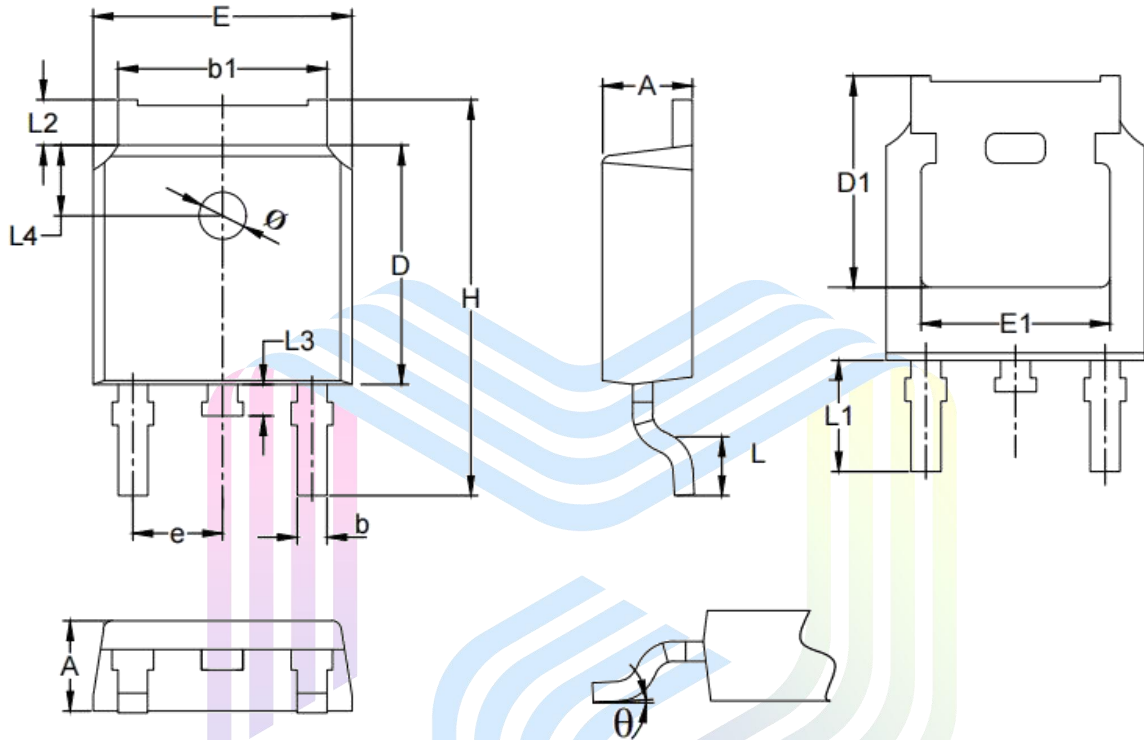
## Electrical Characteristics Diagrams


**Figure 1. Typ. output characteristics**

**Figure 2. Typ. transfer characteristics**

**Figure 3. Typ. capacitances**

**Figure 4. Typ. gate charge**

**Figure 5. Drain-source breakdown voltage**

**Figure 6. Drain-source on-state resistance**


**Figure 7. Threshold voltage**

**Figure 8. Forward characteristic of body diode**

**Figure 9. Drain-source on-state resistance**

**Figure 10. Power dissipation**

**Figure 11. Safe operation area  $T_c=25^\circ\text{C}$** 

**Figure 12. Max. transient thermal impedance**

## Mechanical Dimensions

### TO-252 Package Information



COMMON DIMENSIONS  
(UNITS OF MEASURE=MILLIMETER)

Symbol	MIN	MAX
A	2.2	2.4
A1	0	0.127
A2	-	-
b	0.66	0.9
b1	5.1	5.5
c	0.43	0.61
D	5.95	6.22
D1	5.3REF	
E	6.4	6.75
E1	4.8REF	
e	2.286BSC	
H	9.4	10.5
L	1.38	2
L1	2.9REF	
L2	0.88	1.28
L3	0.5	1
L4	1.8REF	
θ	0°	8°

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